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- **Assembly Note ZZ1**: This Assembly Note is for PCB labels only.
- **Assembly Note ZZ2**: These assemblies are ESD sensitive, ESD precautions shall be observed.
- **Assembly Note ZZ3**: These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- **Assembly Note ZZ4**: These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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